# imall

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#### Features

- Typ. R<sub>DS(on)</sub> = 188 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>q</sub> = 78 nC)
- Low E<sub>oss</sub> (Typ. 7.5 uJ @ 400 V)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 304 pF)
- 100% Avalanche Tested
- RoHS Compliant
- · ESD Improved Capability

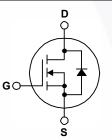
#### Applications

- AC-DC Power Supply
- LED Lighting

### Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		Parameter	FCPF220N80	Unit		
V <sub>DSS</sub>	Drain to Source Voltage		800	V		
V <sub>GSS</sub>	Cata ta Cauraa Maltaga	- DC	- DC		V	
	Gate to Source Voltage	- AC	- AC (f >1 Hz)			
ID	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		23*	А	
		- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		14.6*	— A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	57*	A	
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	ote 2) 645		
I <sub>AR</sub>	Avalanche Current	(Note 1)	4.6	Α		
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	27.8	mJ	
du /dt	MOSFET dv/dt			100	V/ns	
dv/dt	Peak Diode Recovery dv/dt (Note 3)			20		
P <sub>D</sub>	Dower Dissinction	(T <sub>C</sub> = 25°C)		44	W	
	Power Dissipation	- Derate Above 25°C		0.35	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
Τ <sub>L</sub>	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

#### Thermal Characteristics

Symbol	Parameter	FCPF220N80	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.8	°C/W
$R_{ extsf{ heta}JA}$	al Resistance, Junction to Ambient, Max. 62.5		°C/W

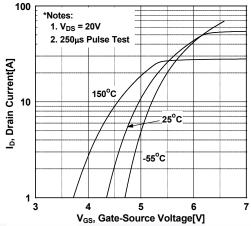
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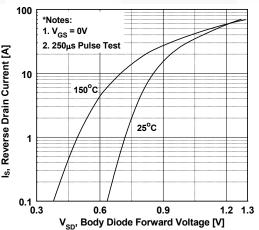
	ımber	Top Mark	Package	Packing Method	Reel Siz	е	Tape Width	Qu	antity
· · · ·		TO-220F	Tube	N/A		N/A	50	50 units	
-1				· · · ·					
		Cteristics T <sub>C</sub> = 25°C	c unless oth			Min	Tree	Mov	110:4
Symbol		Parameter		Test Conditions	5	Min.	Тур.	Max.	Unit
Off Charac	teristics								
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		v V <sub>G</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 25°C		800	-	-	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient		I <sub>D</sub> =	$I_D = 1$ mA, Referenced to 25°C		-	0.8	-	V/ºC
1	Zoro Coto			V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V		-	-	25	
DSS	Zero Gate Voltage Drain Current		VDS	$V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		-	-	250	μA
GSS	Gate to Body Leakage Current		V <sub>G</sub>	$V_{GS} = \pm 20 V, V_{DS} = 0 V$		-	-	±100	nA
On Charac	teristics								
V <sub>GS(th)</sub>	-	shold Voltage	Vo	<sub>S</sub> = V <sub>DS</sub> , I <sub>D</sub> = 2.3 mA		2.5	-	4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance		-	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 11.5 \text{ A}$		-	188	220	mΩ
9FS		ransconductance	-	$_{\rm S} = 20$ V, $I_{\rm D} = 11.5$ A		-	25	-	S
9F5	l'onnara n		1.0				20		U
Dynamic C	haracteri	stics							
C <sub>iss</sub>	Input Capa	acitance	ince			-	3430	4560	pF
C <sub>oss</sub>	Output Cap	pacitance	_	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	100	135	pF
C <sub>rss</sub>	Reverse Tr	ransfer Capacitance	T =				0.3	-	pF
C <sub>oss</sub>	Output Cap	pacitance	VD	<sub>S</sub> = 480 V, V <sub>GS</sub> = 0 V,	f = 1 MHz	-	49	-	pF
C <sub>oss(eff.)</sub>	Effective O	Output Capacitance		$_{\rm S}$ = 0 V to 480 V, V <sub>GS</sub>		-	304	-	pF
Q <sub>q(tot)</sub>		Charge at 10V		<sub>S</sub> = 640 V, I <sub>D</sub> = 23 A,		-	78	105	nC
Q <sub>qs</sub>		urce Gate Charge		$V_{\rm DS} = 640$ V, $I_{\rm D} = 23$ A, $V_{\rm GS} = 10$ V		-	16	-	nC
Q <sub>gd</sub>		ain "Miller" Charge		0	(Note 4)	-	28	-	nC
ESR	Equivalent	Series Resistance	f =	1 MHz		-	0.78	-	Ω
Switching	1								
t <sub>d(on)</sub>	Turn-On De	elay Time		$V_{DD}$ = 400 V, I <sub>D</sub> = 23 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω		-	27	64	ns
t <sub>r</sub>	Turn-On Ri					-	19	48	ns
t <sub>d(off)</sub>	Turn-Off De	elay Time	v <sub>G</sub>			-	75	160	ns
t <sub>f</sub>	Turn-Off Fa	all Time			(Note 4)	-	2.6	15	ns
	rce Diode	Characteristics							
Drain-Sour				nward Current			_	23	А
		Continuous Drain to Sour						57	A
s	Maximum (	Continuous Drain to Sour		rd Current			-		
ls Ism	Maximum ( Maximum F	Pulsed Drain to Source D	iode Forwa			-	-		
s	Maximum ( Maximum F Drain to So		iode Forwar age V <sub>G</sub>	rd Current $_{S} = 0 V, I_{SD} = 23 A$ $_{S} = 0 V, I_{SD} = 23 A,$		-	- - 560	1.2	V ns

#### **Typical Performance Characteristics Figure 1. On-Region Characteristics** 100 V<sub>GS</sub> = 10.0V 8.0V 7.0V 6.0V 5.5V I<sub>D</sub>, Drain Current[A] l<sub>b</sub>, Drain Current[A] 5.0V 10 \*Notes: 1. 250µs Pulse Test 2. $T_{C} = 25^{\circ}C$ 1 └ 0.3 1 V<sub>DS</sub>, Drain-Source Voltage[V] 10 20 Figure 3. On-Resistance Variation vs. **Drain Current and Gate Voltage** 0.4 \*Note: T<sub>c</sub> = 25°C **Drain-Source On-Resistance** Reverse Drain Current [A] 0.3 R<sub>DS(ON)</sub> [Ω], V<sub>GS</sub> = 10V 0.2 V<sub>GS</sub> = 20V <u>ő</u> 0.1 0 12 24 36 48 60 I<sub>D</sub>, Drain Current [A] **Figure 5. Capacitance Characteristics** 100000 Gate-Source Voltage [V] 10000 Ciss 1000 Capacitances [pF] Coss 100 \*Note: 10 1. V<sub>GS</sub> = 0V V<sub>GS</sub>, 2. f = 1MHz Crss Ciss = Cgs + Cgd (Cds = shorted) 1 $C_{oss} = C_{ds} + C_{gd}$ C<sub>rss</sub> = C<sub>gd</sub> 0.1 <sup>∟</sup> 0.1 1 10 100 800 V<sub>DS</sub>, Drain-Source Voltage [V]

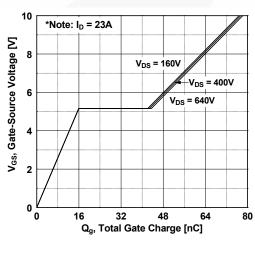
## Figure 2. Transfer Characteristics



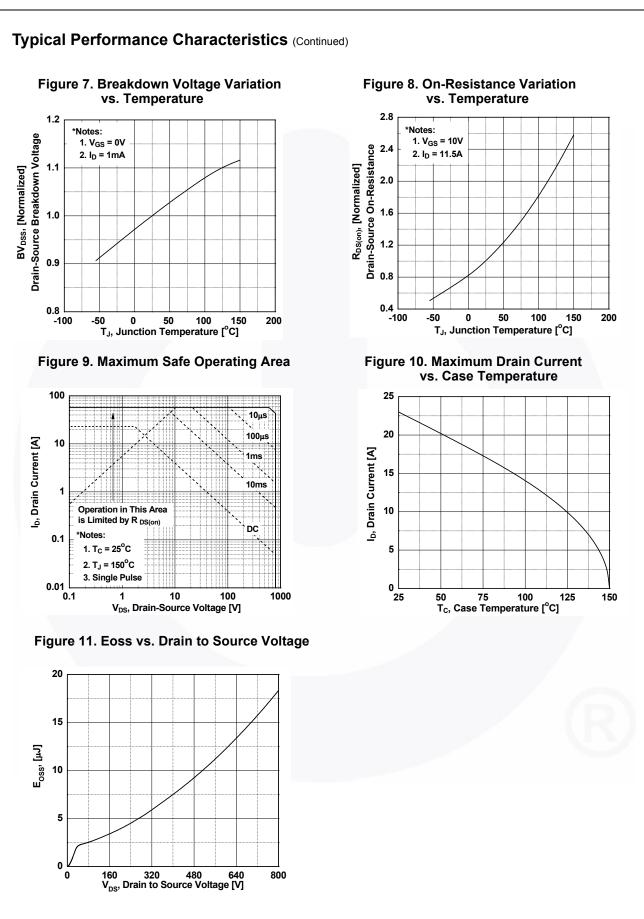
#### Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



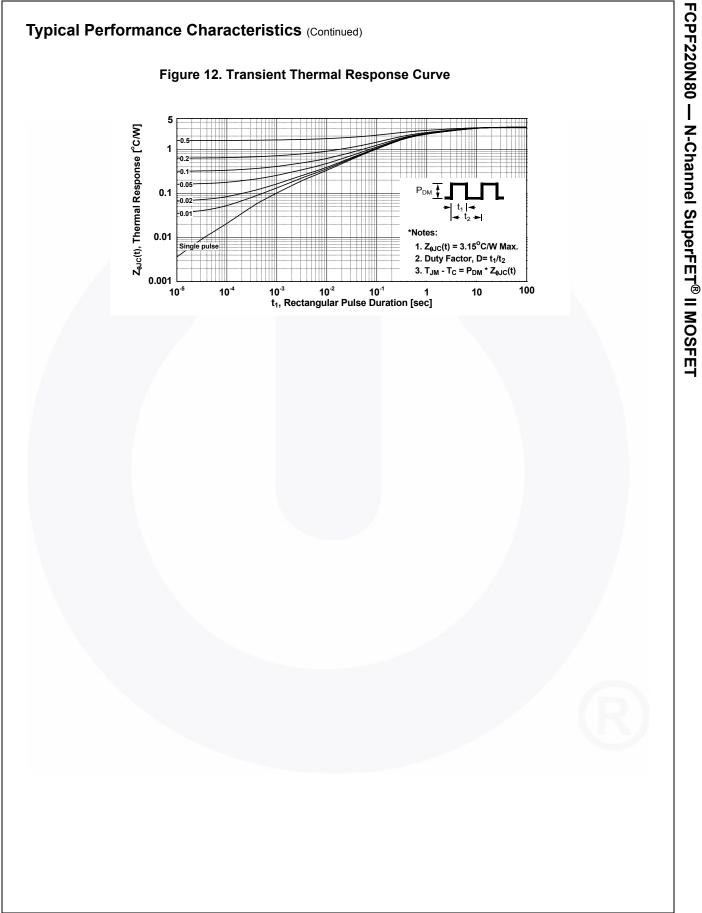
## Figure 6. Gate Charge Characteristics

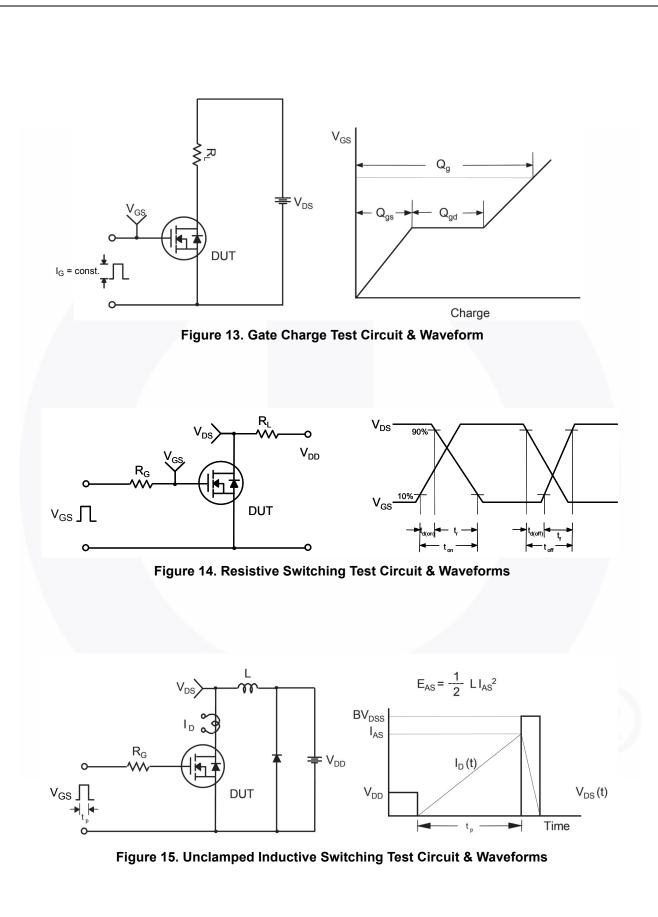






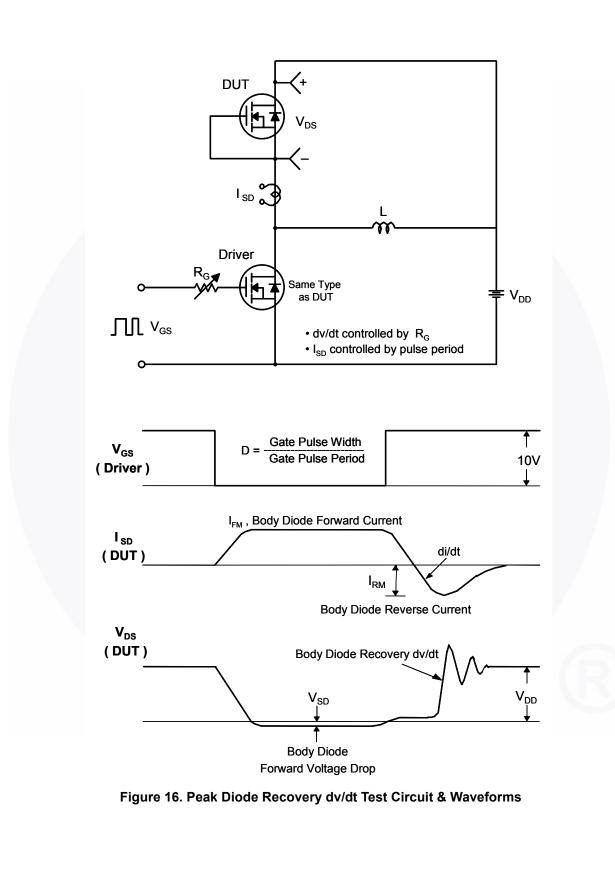
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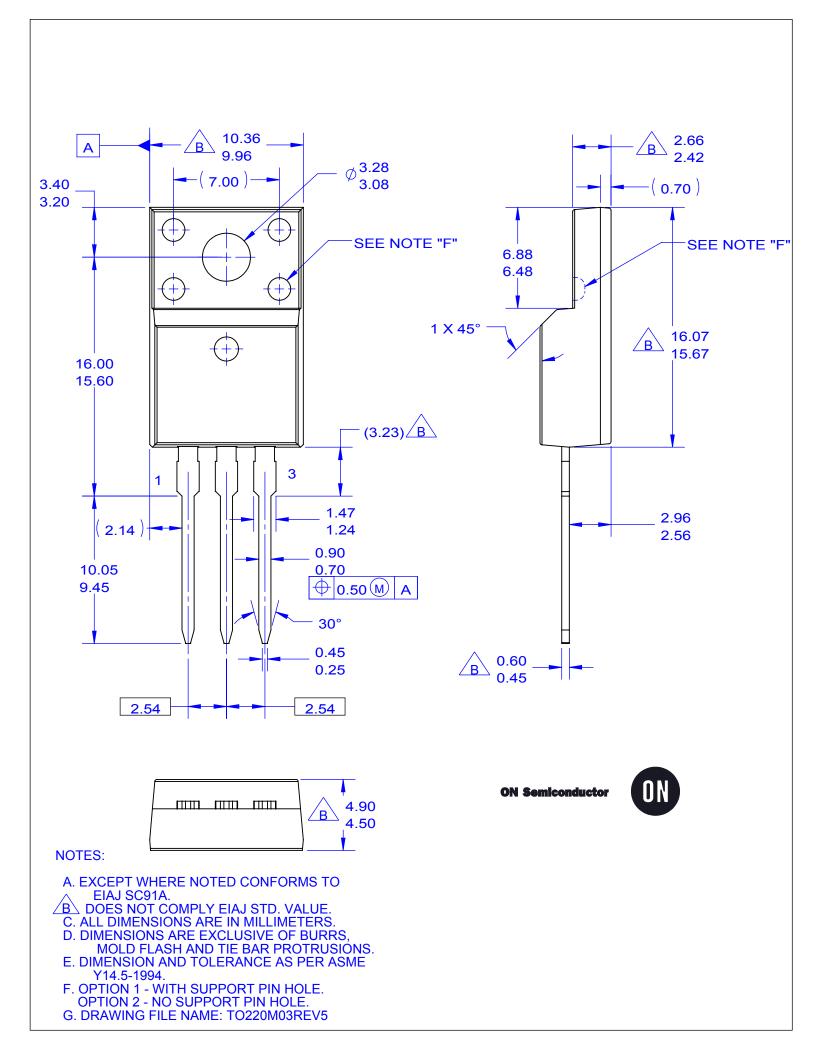




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